



DESD3V3S1BLP3

LOW CAPACITANCE BIDIRECTIONAL TVS DIODE

Features

- Ultra-Small, Low Profile Leadless Surface Mount Package (0.6 x 0.3 x 0.3mm)
- Provides ESD Protection per IEC 61000-4-2 Standard: Air – ±30kV, Contact – ±25kV
- 1 Channel of ESD Protection
- Low Channel Input Capacitance
- Typically Used in Cellular Handsets, Portable Electronics, Communication Systems, Computers and Peripherals
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: X3-DFN0603-2
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.0002 grams (Approximate)



Bottom View

X3-DFN0603-2

Top View



Device Schematic

Ordering Information (Note 4)

Product	Compliance	Marking	Reel Size(inches)	Tape Width(mm)	Quantity per Reel
DESD3V3S1BLP3-7	Standard	S	7	8	10,000/Tape & Reel

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information

X3-DFN0603-2

S

S = Product Type Marking Code

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Power Dissipation	P _{PP}	35	W	8/20µs, Per Fig. 3
Peak Pulse Current	IPP	5	А	8/20µs, Per Fig. 3
ESD Protection – Contact Discharge	V _{ESD_Contact}	±25	kV	IEC 61000-4-2 Standard
ESD Protection – Air Discharge	$V_{ESD_{Air}}$	±30	kV	IEC 61000-4-2 Standard



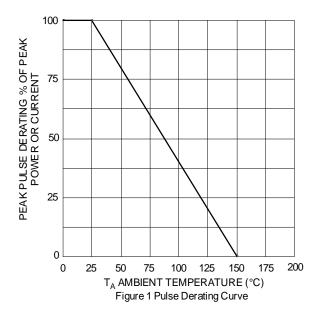
Thermal Characteristics

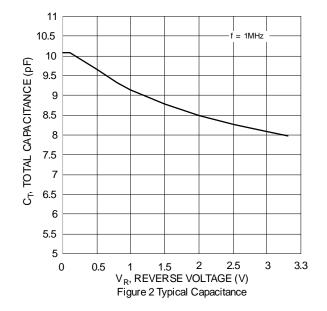
Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 5)	PD	250	mW
Thermal Resistance, Junction to Ambient (Note 5)	R _{θJA}	500	°C/W
Operating and Storage Temperature Range	TJ, T _{STG}	-65 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Standoff Voltage	V _{RWM}	_	_	3.3	V	—
Channel Leakage Current (Note 6)	I _{RM}	—	10	100	nA	$V_{RWM} = 3.3V$
Clamping Voltage, Positive Transients	V _{CL}		4.5 5.8	5.4 7.0	V	I _{PP} = 1A, t _P = 8/20µs I _{PP} = 5A, t _P = 8/20µs
Breakdown Voltage	V _{BR}	3.8	_	6.5	V	$I_{R} = 1mA$
Differential Resistance	R _{DIF}	—	0.3	—	Ω	I _R = 1A
Channel Input Capacitance	CT	_	10	13	pF	$V_R = 0V$, f = 1MHz

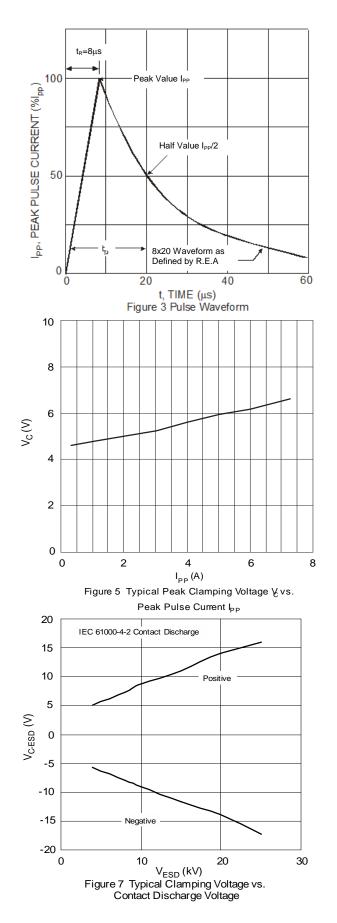
Notes: 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes Incorporated's suggested pad layout, which can be found on our website http://www.diodes.com/package-outlines.html.
6. Short duration pulse test used to minimize self-heating effect.

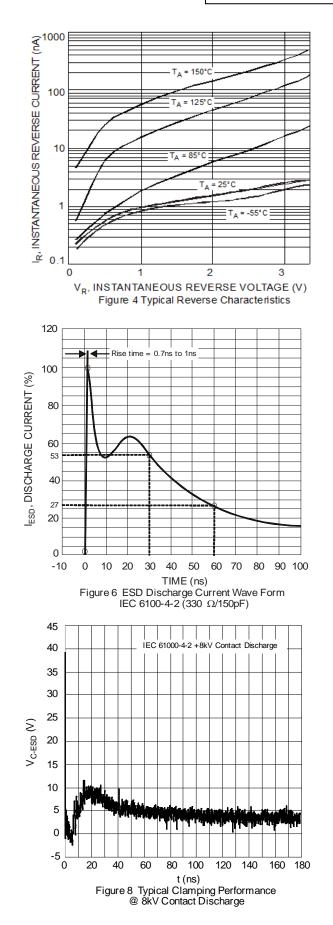




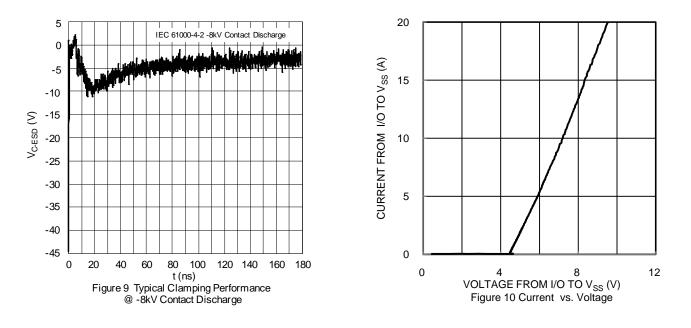


DESD3V3S1BLP3



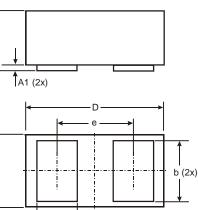






Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.



X3-DFN0603-2

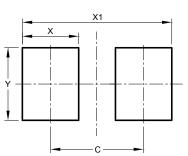
X3-DFN0603-2						
Dim	Min	Max	Тур			
Α	0.27	0.35	0.30			
A1	0.00	0.03	0.02			
b	0.19	0.29	0.24			
D	0.595	0.645	0.62			
Е	0.295	0.345	0.32			
e	-	-	0.355			
L	0.14	0.24	0.19			
All Dimensions in mm						

Suggested Pad Layout

Е

Please see http://www.diodes.com/package-outlines.html for the latest version.

L (2x)



X3-DFN0603-2

Dimensions	Value (in mm)
С	0.380
Х	0.230
X1	0.610
Y	0.300



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